

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT3715498

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HIROKO KASHIMOTO	01/21/2016
RECEIVING PARTY DATA	
Name:	DAIKIN INDUSTRIES LTD.
Street Address:	UMEDA CENTER BUILDING, 4-12 NAKAZAKI-NISHI 2-CHOME, KITA-KU
City:	OSAKA-SHI, OSAKA-FU
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29551254
CORRESPONDENCE DATA	
Fax Number:	(703)519-7769
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	703-519-9785
Email:	office@uspatentagents.com
Correspondent Name:	KANESAKA BERNER AND PARTNERS LLP
Address Line 1:	2318 MILL ROAD
Address Line 2:	SUITE 1400
Address Line 4:	ALEXANDRIA, VIRGINIA 22314-2848
ATTORNEY DOCKET NUMBER:	NOZ-395DES
NAME OF SUBMITTER:	MANABU KANESAKA
SIGNATURE:	/Manabu Kanesaka/
DATE SIGNED:	01/28/2016
Total Attachments: 1	
source=2016-01-28-Assignment#page1.tif	

ASSIGNMENT

For value received, I, Hiroko KASHIMOTO having post office address at c/o Shiga Plant, DAIKIN INDUSTRIES LTD., 1000-2, Okamoto-cho, Kusatsu-shi, Shiga, 525-8526 JAPAN hereby sell, assign and transfer to DAIKIN INDUSTRIES LTD. a corporation existing under the laws of Japan located at UMEDA CENTER BUILDING, 4-12 Nakazaki-Nishi 2-chome, Kita-ku, Osaka-shi, Osaka-fu, JAPAN and its successors, assigns, and legal representatives the entire right, title, and interest for all countries including the United States of America, in and to certain inventions relating to TEMPERATURE SENSOR described in application for Letters Patent of the United States, Serial No. 29/551,254 Filed January 12, 2016 and all patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and Trademarks to issue all patents on said improvements or resulting therefrom to said Company as assignee of the entire interest, and covenant that I have full right so to do, and agree that I will communicate to said Company or its representatives any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Company, its successors, assigns, and nominees, to obtain and enforce proper protection for said invention in the United States.

Signature

Hiroko Kashimoto

Date

2016/1/21

Hiroko KASHIMOTO